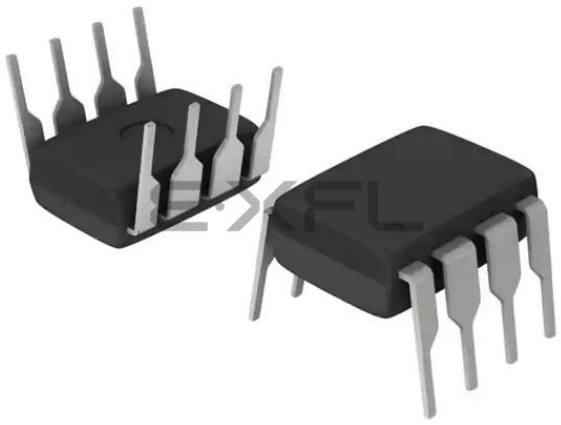

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12hv609-e-p

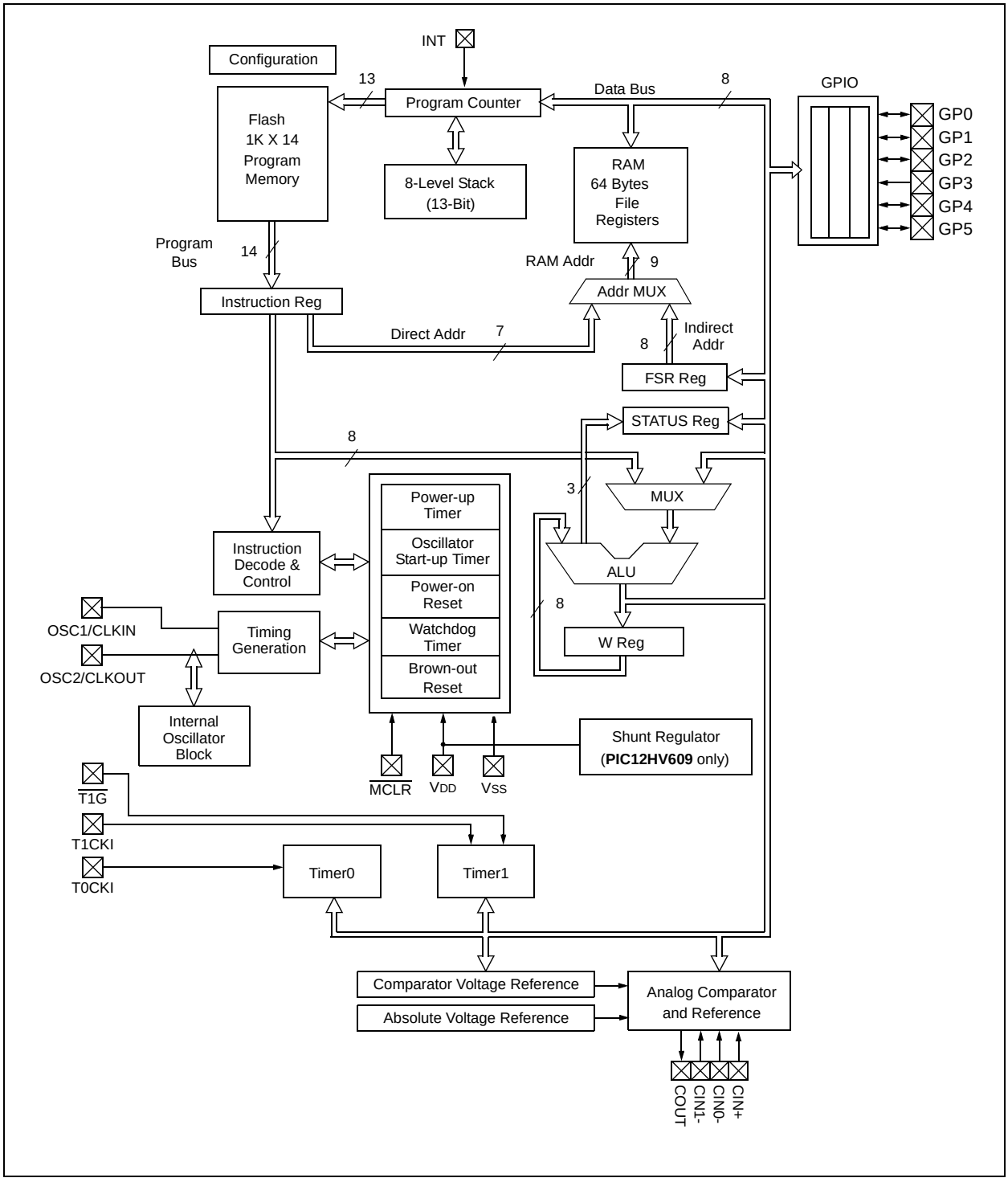
1.0 DEVICE OVERVIEW

The PIC12F609/615/617/12HV609/615 devices are covered by this data sheet. They are available in 8-pin PDIP, SOIC, MSOP and DFN packages.

Block Diagrams and pinout descriptions of the devices are as follows:

- PIC12F609/HV609 (Figure 1-1, Table 1-1)
- PIC12F615/617/HV615 (Figure 1-2, Table 1-2)

FIGURE 1-1: PIC12F609/HV609 BLOCK DIAGRAM



2.2.1 GENERAL PURPOSE REGISTER FILE

The register file is organized as 64 x 8 in the PIC12F609/615/12HV609/615, and as 128 x 8 in the PIC12F617. Each register is accessed, either directly or indirectly, through the File Select Register (FSR) (see **Section 2.4 "Indirect Addressing, INDF and FSR Registers"**).

2.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral functions for controlling the desired operation of the device (see Table 2-1). These registers are static RAM.

The special registers can be classified into two sets: core and peripheral. The Special Function Registers associated with the "core" are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

FIGURE 2-3: DATA MEMORY MAP OF THE PIC12F609/HV609

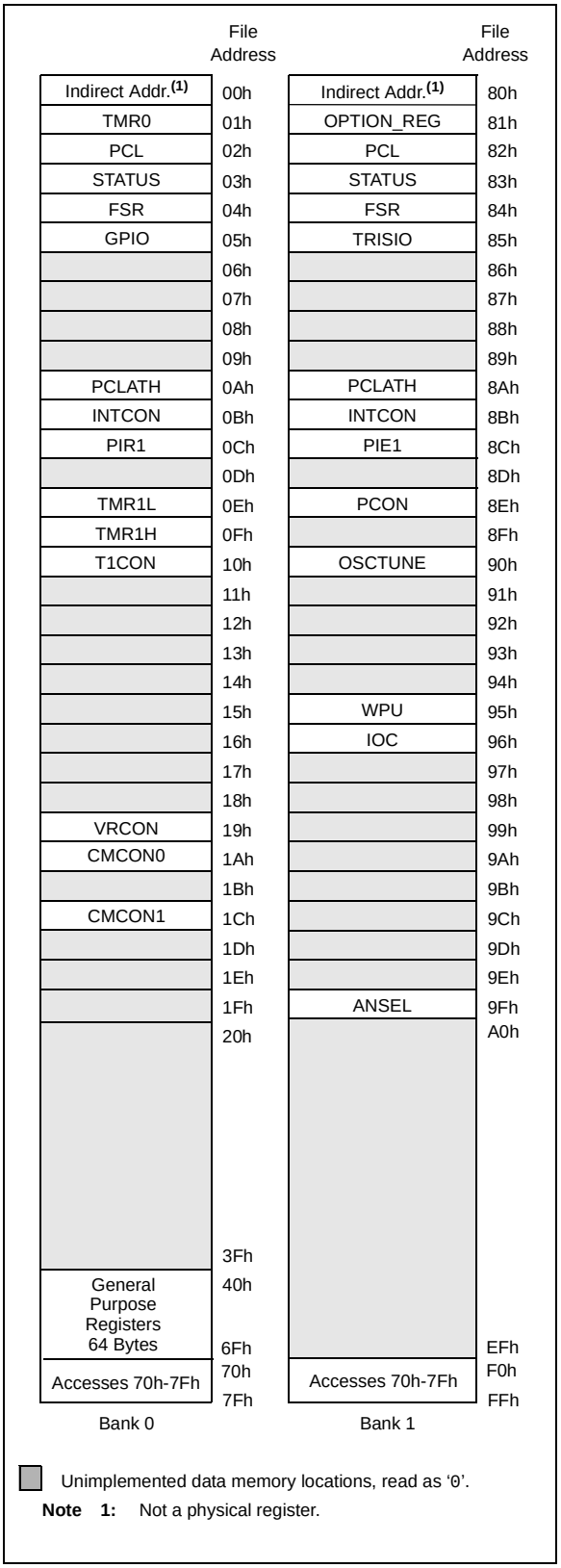
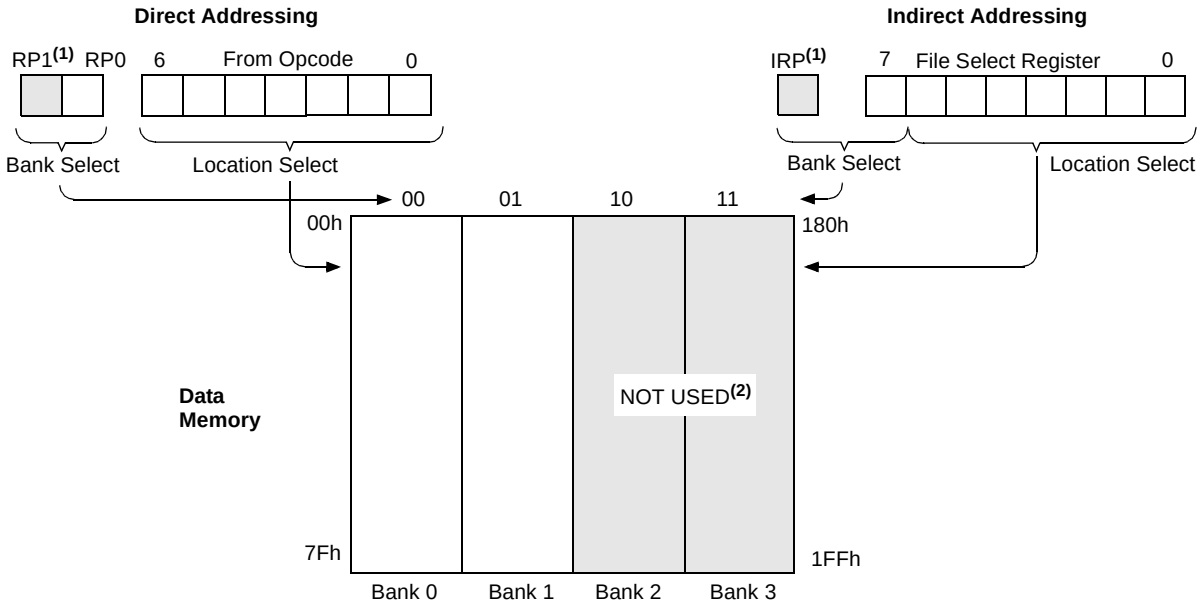


FIGURE 2-6: DIRECT/INDIRECT ADDRESSING PIC12F609/615/617/12HV609/615



For memory map detail, see Figure 2-3.

Note 1: The RP1 and IRP bits are reserved; always maintain these bits clear.

2: Accesses in this area are mirrored back into Bank 0 and Bank 1.

REGISTER 5-2: TRISIO: GPIO TRI-STATE REGISTER

U-0	U-0	R/W-1	R/W-1	R-1	R/W-1	R/W-1	R/W-1
—	—	TRISIO5	TRISIO4	TRISIO3	TRISIO2	TRISIO1	TRISIO0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented**: Read as '0'

bit 5-0 **TRISIO<5:0>:** GPIO Tri-State Control bit
1 = GPIO pin configured as an input (tri-stated)
0 = GPIO pin configured as an output

Note 1: TRISIO<3> always reads '1'.
2: TRISIO<5:4> always reads '1' in XT, HS and LP Oscillator modes.

5.2 Additional Pin Functions

Every GPIO pin on the PIC12F609/615/617/12HV609/615 has an interrupt-on-change option and a weak pull-up option. The next three sections describe these functions.

5.2.1 ANSEL REGISTER

The ANSEL register is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSEL bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSEL bits has no affect on digital output functions. A pin with TRIS clear and ANSEL set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

5.2.2 WEAK PULL-UPS

Each of the GPIO pins, except GP3, has an individually configurable internal weak pull-up. Control bits WPUx enable or disable each pull-up. Refer to Register 5-5. Each weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on a Power-on Reset by the $\overline{GPPU}$ bit of the OPTION register). A weak pull-up is automatically enabled for GP3 when configured as $\overline{MCLR}$ and disabled when GP3 is an I/O. There is no software control of the $\overline{MCLR}$ pull-up.

5.2.3 INTERRUPT-ON-CHANGE

Each GPIO pin is individually configurable as an interrupt-on-change pin. Control bits IOCx enable or disable the interrupt function for each pin. Refer to Register 5-6. The interrupt-on-change is disabled on a Power-on Reset.

For enabled interrupt-on-change pins, the values are compared with the old value latched on the last read of GPIO. The 'mismatch' outputs of the last read are OR'd together to set the GPIO Change Interrupt Flag bit (GPIF) in the INTCON register (Register 2-3).

This interrupt can wake the device from Sleep. The user, in the Interrupt Service Routine, clears the interrupt by:

a) Any read of GPIO AND Clear flag bit GPIF. This will end the mismatch condition;

OR

b) Any write of GPIO AND Clear flag bit GPIF will end the mismatch condition;

A mismatch condition will continue to set flag bit GPIF. Reading GPIO will end the mismatch condition and allow flag bit GPIF to be cleared. The latch holding the last read value is not affected by a $\overline{MCLR}$ nor BOR Reset. After these resets, the GPIF flag will continue to be set if a mismatch is present.

Note:	If a change on the I/O pin should occur when any GPIO operation is being executed, then the GPIF interrupt flag may not get set.

10.2.7 ADC REGISTER DEFINITIONS

The following registers are used to control the operation of the ADC.

REGISTER 10-1: ADCON0: A/D CONTROL REGISTER 0

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	VCFG	—	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ADFM:** A/D Conversion Result Format Select bit
1 = Right justified
0 = Left justified

bit 6 **VCFG:** Voltage Reference bit
1 = V_{REF} pin
0 = V_{DD}

bit 5 **Unimplemented:** Read as '0'

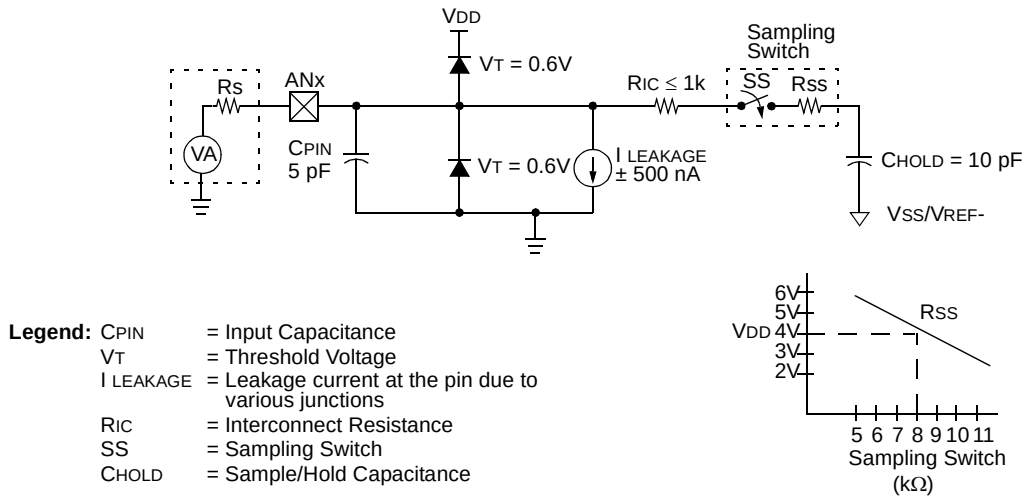
bit 4-2 **CHS<2:0>: Analog Channel Select bits**
000 = Channel 00 (AN0)
001 = Channel 01 (AN1)
010 = Channel 02 (AN2)
011 = Channel 03 (AN3)
100 = CV_{REF}
101 = 0.6V Reference
110 = 1.2V Reference
111 = Reserved. Do not use.

bit 1 **GO/$\overline{\text{DONE}}$:** A/D Conversion Status bit
1 = A/D conversion cycle in progress. Setting this bit starts an A/D conversion cycle.
This bit is automatically cleared by hardware when the A/D conversion has completed.
0 = A/D conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit
1 = ADC is enabled
0 = ADC is disabled and consumes no operating current

Note 1: When the CHS<2:0> bits change to select the 1.2V or 0.6V reference, the reference output voltage will have a transient. If the Comparator module uses this 0.6V reference voltage, the comparator output may momentarily change state due to the transient.

FIGURE 10-4: ANALOG INPUT MODEL



Legend: CPIN = Input Capacitance
VT = Threshold Voltage
I LEAKAGE = Leakage current at the pin due to various junctions
RIC = Interconnect Resistance
SS = Sampling Switch
CHOLD = Sample/Hold Capacitance

FIGURE 10-5: ADC TRANSFER FUNCTION

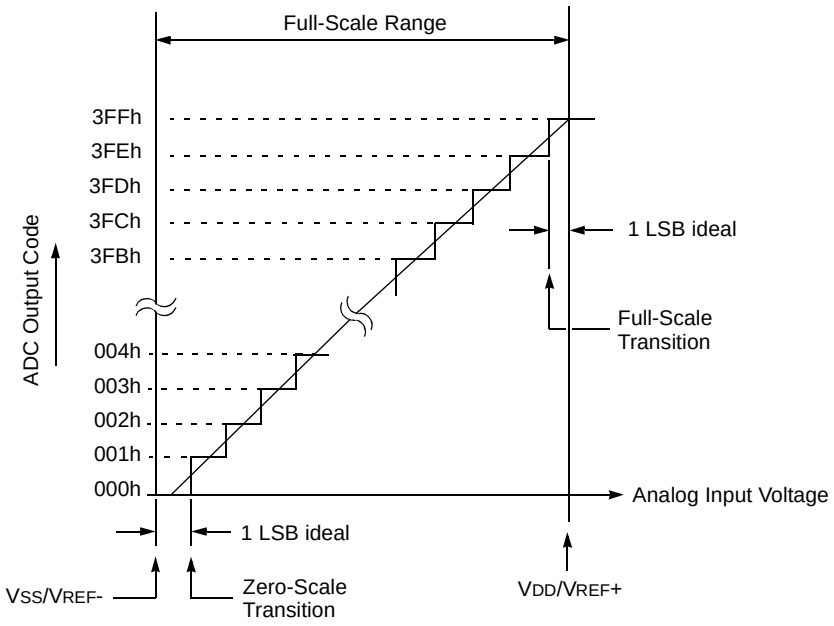


TABLE 10-2: SUMMARY OF ASSOCIATED ADC REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
ADCON0(1)	ADFM	VCFG	—	CHS2	CHS1	CHS0	GO/$\overline{\text{DONE}}$	ADON	00-0 0000	00-0 0000
ANSEL	—	ADCS2(1)	ADCS1(1)	ADCS0(1)	ANS3	ANS2(1)	ANS1	ANS0	-000 1111	-000 1111
ADRESH(1,2)	A/D Result Register High Byte								xxxx xxxx	uuuu uuuu
ADRESL(1,2)	A/D Result Register Low Byte								xxxx xxxx	uuuu uuuu
GPIO	—	—	GP5	GP4	GP3	GP2	GP1	GP0	--x0 x000	--x0 x000
INTCON	GIE	PEIE	T0IE	INTE	GPIE	T0IF	INTF	GPIF	0000 0000	0000 0000
PIE1	—	ADIE(1)	CCP1IE(1)	—	CMIE	—	TMR2IE(1)	TMR1IE	-00- 0-00	-00- 0-00
PIR1	—	ADIF(1)	CCP1IF(1)	—	CMIF	—	TMR2IF(1)	TMR1IF	-00- 0-00	-00- 0-00
TRISIO	—	—	TRISIO5	TRISIO4	TRISIO3	TRISIO2	TRISIO1	TRISIO0	--11 1111	--11 1111

Legend: x = unknown, u = unchanged, – = unimplemented read as '0'. Shaded cells are not used for ADC module.

Note 1: For PIC12F615/617/HV615 only.

2: Read Only Register.

11.1 Capture Mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 register when an event occurs on pin CCP1. An event is defined as one of the following and is configured by the CCP1M<3:0> bits of the CCP1CON register:

- Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

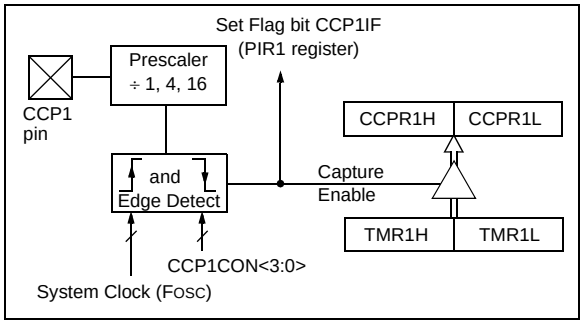
When a capture is made, the Interrupt Request Flag bit CCP1IF of the PIR1 register is set. The interrupt flag must be cleared in software. If another capture occurs before the value in the CCPR1H, CCPR1L register pair is read, the old captured value is overwritten by the new captured value (see Figure 11-1).

11.1.1 CCP1 PIN CONFIGURATION

In Capture mode, the CCP1 pin should be configured as an input by setting the associated TRIS control bit.

Note:	If the CCP1 pin is configured as an output, a write to the port can cause a capture condition.

FIGURE 11-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



11.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

11.1.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCP1IE interrupt enable bit of the PIE1 register clear to avoid false interrupts. Additionally, the user should clear the CCP1IF interrupt flag bit of the PIR1 register following any change in operating mode.

11.1.4 CCP PRESCALER

There are four prescaler settings specified by the CCP1M<3:0> bits of the CCP1CON register. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. Any Reset will clear the prescaler counter.

Switching from one capture prescaler to another does not clear the prescaler and may generate a false interrupt. To avoid this unexpected operation, turn the module off by clearing the CCP1CON register before changing the prescaler (see Example 11-1).

EXAMPLE 11-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
BANKSEL CCP1CON     ;Set Bank bits to point
                    ;to CCP1CON
CLRF    CCP1CON     ;Turn CCP module off
MOVLW   NEW_CAPT_PS;Load the W reg with
                    ; the new prescaler
                    ; move value and CCP ON
MOVWF   CCP1CON     ;Load CCP1CON with this
                    ; value
```

11.3 PWM Mode

The PWM mode generates a Pulse-Width Modulated signal on the CCP1 pin. The duty cycle, period and resolution are determined by the following registers:

- PR2
- T2CON
- CCPR1L
- CCP1CON

In Pulse-Width Modulation (PWM) mode, the CCP module produces up to a 10-bit resolution PWM output on the CCP1 pin. Since the CCP1 pin is multiplexed with the PORT data latch, the TRIS for that pin must be cleared to enable the CCP1 pin output driver.

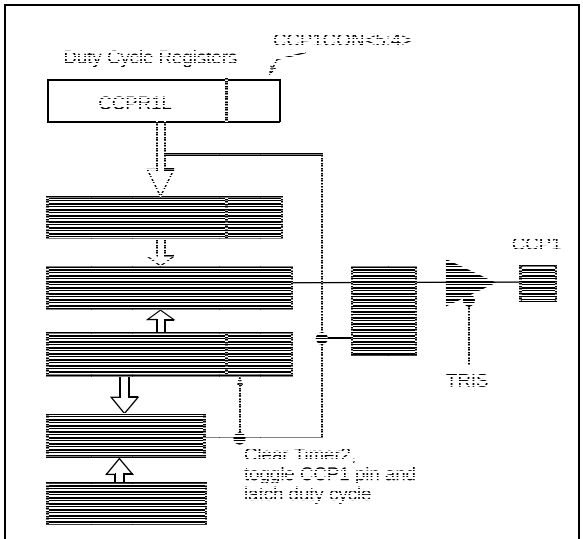
Note:	Clearing the CCP1CON register will relinquish CCP1 control of the CCP1 pin.

Figure 11-3 shows a simplified block diagram of PWM operation.

Figure 11-4 shows a typical waveform of the PWM signal.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 11.3.7 "Setup for PWM Operation"**.

FIGURE 11-3: SIMPLIFIED PWM BLOCK DIAGRAM

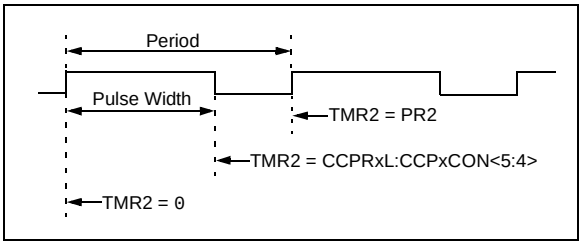


Note 1: The 8-bit timer TMR2 register is concatenated with the 2-bit internal system clock (F_{OSC}), or 2 bits of the prescaler, to create the 10-bit time base.

2: In PWM mode, CCPR1H is a read only register.

The PWM output (Figure 11-4) has a time base (period) and a time that the output stays high (duty cycle).

FIGURE 11-4: CCP PWM OUTPUT



11.3.4 OPERATION IN SLEEP MODE

In Sleep mode, the TMR2 register will not increment and the state of the module will not change. If the CCP1 pin is driving a value, it will continue to drive that value. When the device wakes up, TMR2 will continue from its previous state.

11.3.5 CHANGES IN SYSTEM CLOCK FREQUENCY

The PWM frequency is derived from the system clock frequency. Any changes in the system clock frequency will result in changes to the PWM frequency. See **Section 4.0 "Oscillator Module"** for additional details.

11.3.6 EFFECTS OF RESET

Any Reset will force all ports to Input mode and the CCP registers to their Reset states.

11.3.7 SETUP FOR PWM OPERATION

The following steps should be taken when configuring the CCP module for PWM operation:

1. Disable the PWM pin (CCP1) output drivers by setting the associated TRIS bit.
2. Set the PWM period by loading the PR2 register.
3. Configure the CCP module for the PWM mode by loading the CCP1CON register with the appropriate values.
4. Set the PWM duty cycle by loading the CCPR1L register and DC1B bits of the CCP1CON register.
5. Configure and start Timer2:
   - Clear the TMR2IF interrupt flag bit of the PIR1 register.
   - Set the Timer2 prescale value by loading the T2CKPS bits of the T2CON register.
   - Enable Timer2 by setting the TMR2ON bit of the T2CON register.
6. Enable PWM output after a new PWM cycle has started:
   - Wait until Timer2 overflows (TMR2IF bit of the PIR1 register is set).
   - Enable the CCP1 pin output driver by clearing the associated TRIS bit.

11.4 PWM (Enhanced Mode)

The Enhanced PWM Mode can generate a PWM signal on up to four different output pins with up to 10-bits of resolution. It can do this through four different PWM output modes:

- Single PWM
- Half-Bridge PWM

To select an Enhanced PWM mode, the P1M bits of the CCP1CON register must be set appropriately.

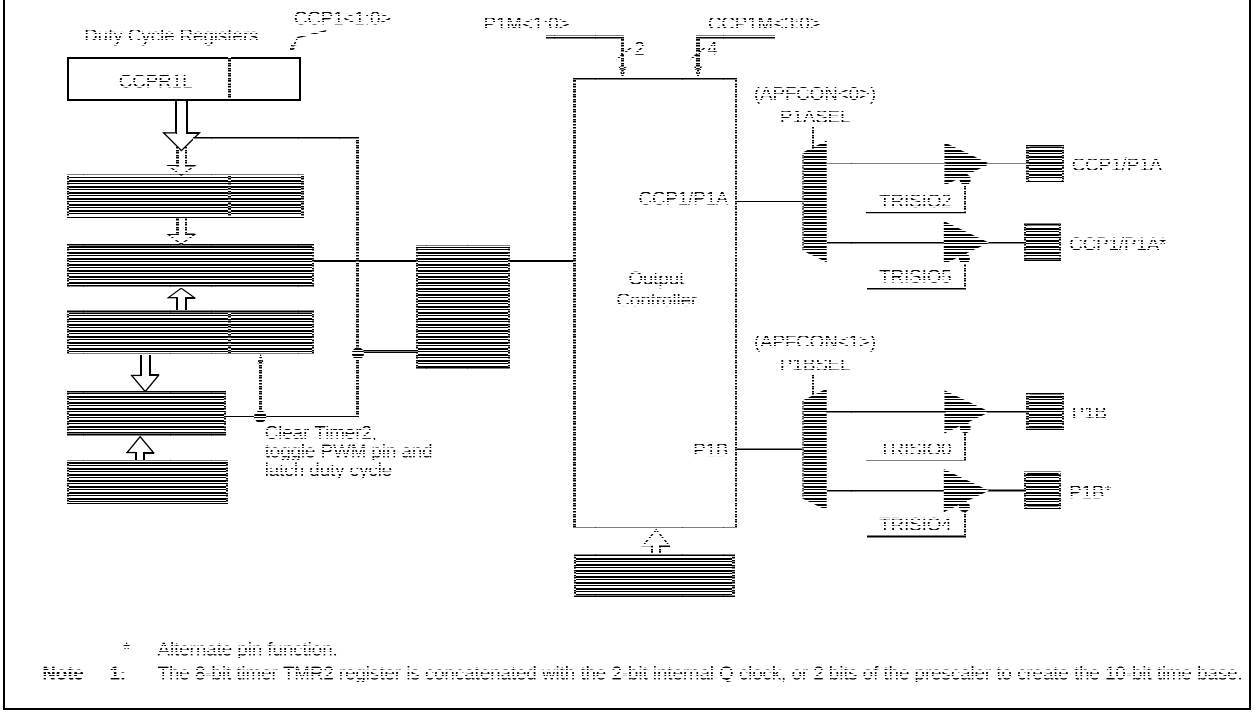
The PWM outputs are multiplexed with I/O pins and are designated P1A and P1B. The polarity of the PWM pins is configurable and is selected by setting the CCP1M bits in the CCP1CON register appropriately.

Table 11-6 shows the pin assignments for each Enhanced PWM mode.

Figure 11-5 shows an example of a simplified block diagram of the Enhanced PWM module.

Note:	To prevent the generation of an incomplete waveform when the PWM is first enabled, the ECCP module waits until the start of a new PWM period before generating a PWM signal.

FIGURE 11-5: EXAMPLE SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODE



* Alternate pin function.

Note 1: The 8 bit timer TMR2 register is concatenated with the 2 bit internal Q clock, or 2 bits of the prescaler to create the 10 bit time base.

Note 1:	The TRIS register value for each PWM output must be configured appropriately.
2:	Clearing the CCP1CON register will relinquish ECCP control of all PWM output pins.
3:	Any pin not used by an Enhanced PWM mode is available for alternate pin functions.

TABLE 11-6: EXAMPLE PIN ASSIGNMENTS FOR VARIOUS PWM ENHANCED MODES

ECCP Mode	P1M<1:0>	CCP1/P1A	P1B
Single	00	Yes(1)	Yes(1)
Half-Bridge	10	Yes	Yes

TABLE 12-5: INITIALIZATION CONDITION FOR REGISTERS (PIC12F615/617/HV615)

Register	Address	Power-on Reset	$\overline{\text{MCLR}}$ Reset WDT Reset Brown-out Reset(1)	Wake-up from Sleep through Interrupt Wake-up from Sleep through WDT Time-out
W	—	xxxx xxxx	uuuu uuuu	uuuu uuuu
INDF	00h/80h	xxxx xxxx	xxxx xxxx	uuuu uuuu
TMR0	01h	xxxx xxxx	uuuu uuuu	uuuu uuuu
PCL	02h/82h	0000 0000	0000 0000	PC + 1(3)
STATUS	03h/83h	0001 1xxx	000q quuu(4)	uuuq quuu(4)
FSR	04h/84h	xxxx xxxx	uuuu uuuu	uuuu uuuu
GPIO	05h	--x0 x000	--u0 u000	--uu uuuu
PCLATH	0Ah/8Ah	---0 0000	---0 0000	---u uuuu
INTCON	0Bh/8Bh	0000 0000	0000 0000	uuuu uuuu(2)
PIR1	0Ch	-000 0-00	-000 0-00	-uuu u-uu(2)
TMR1L	0Eh	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR1H	0Fh	xxxx xxxx	uuuu uuuu	uuuu uuuu
T1CON	10h	0000 0000	uuuu uuuu	-uuu uuuu
TMR2(1)	11h	0000 0000	0000 0000	uuuu uuuu
T2CON(1)	12h	-000 0000	-000 0000	-uuu uuuu
CCPR1L(1)	13h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1H(1)	14h	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON(1)	15h	0-00 0000	0-00 0000	u-uu uuuu
PWM1CON(1)	16h	0000 0000	0000 0000	uuuu uuuu
ECCPAS(1)	17h	0000 0000	0000 0000	uuuu uuuu
VRCON	19h	0-00 0000	0-00 0000	u-uu uuuu
CMCON0	1Ah	0000 -0-0	0000 -0-0	uuuu -u-u
CMCON1	1Ch	---0 0-10	---0 0-10	---u u-qu
ADRESH(1)	1Eh	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0(1)	1Fh	00-0 0000	00-0 0000	uu-u uuuu
OPTION_REG	81h	1111 1111	1111 1111	uuuu uuuu
TRISIO	85h	--11 1111	--11 1111	--uu uuuu
PIE1	8Ch	-00- 0-00	-00- 0-00	-uu- u-uu
PCON	8Eh	---- --0x	---- --uu(1, 5)	---- --uu
OSCTUNE	90h	---0 0000	---u uuuu	---u uuuu
PR2	92h	1111 1111	1111 1111	1111 1111
APFCON	93h	---0 --00	---0 --00	---u --uu
WPU	95h	--11 -111	--11 -111	--uu -uuu
IOC	96h	--00 0000	--00 0000	--uu uuuu
PMCON1(6)	98h	---- -000	---- -000	---- -uuu
PMCON2(6)	99h	---- ----	---- ----	---- ----
PMADRL(6)	9Ah	0000 0000	0000 0000	uuuu uuuu

Legend: u = unchanged, x = unknown, – = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If VDD goes too low, Power-on Reset will be activated and registers will be affected differently.

2: One or more bits in INTCON and/or PIR1 will be affected (to cause wake-up).

3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

4: See Table 12-6 for Reset value for specific condition.

5: If Reset was due to brown-out, then bit 0 = 0. All other Resets will cause bit 0 = u.

6: For PIC12F617 only.

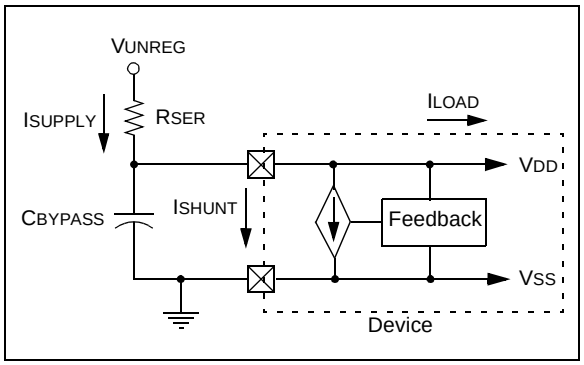
13.0 VOLTAGE REGULATOR

The PIC12HV609/HV615 devices include a permanent internal 5 volt (nominal) shunt regulator in parallel with the VDD pin. This eliminates the need for an external voltage regulator in systems sourced by an unregulated supply. All external devices connected directly to the VDD pin will share the regulated supply voltage and contribute to the total VDD supply current (ILOAD).

13.1 Regulator Operation

A shunt regulator generates a specific supply voltage by creating a voltage drop across a pass resistor RSER. The voltage at the VDD pin of the microcontroller is monitored and compared to an internal voltage reference. The current through the resistor is then adjusted, based on the result of the comparison, to produce a voltage drop equal to the difference between the supply voltage VUNREG and the VDD of the microcontroller. See Figure 13-1 for voltage regulator schematic.

FIGURE 13-1: VOLTAGE REGULATOR



An external current limiting resistor, RSER, located between the unregulated supply, VUNREG, and the VDD pin, drops the difference in voltage between VUNREG and VDD. RSER must be between RMAX and RMIN as defined by Equation 13-1.

EQUATION 13-1: RSER LIMITING RESISTOR

$$R_{MAX} = \frac{(VU_{MIN} - 5V)}{1.05 \bullet (4\ mA + I_{LOAD})}$$

$$R_{MIN} = \frac{(VU_{MAX} - 5V)}{0.95 \bullet (50\ mA)}$$

Where:

RMAX = maximum value of RSER (ohms)

RMIN = minimum value of RSER (ohms)

VUMIN = minimum value of VUNREG

VUMAX = maximum value of VUNREG

VDD = regulated voltage (5V nominal)

ILOAD = maximum expected load current in mA including I/O pin currents and external circuits connected to VDD.

1.05 = compensation for +5% tolerance of RSER

0.95 = compensation for -5% tolerance of RSER

13.2 Regulator Considerations

The supply voltage VUNREG and load current are not constant. Therefore, the current range of the regulator is limited. Selecting a value for RSER must take these three factors into consideration.

Since the regulator uses the band gap voltage as the regulated voltage reference, this voltage reference is permanently enabled in the PIC12HV609/HV615 devices.

The shunt regulator will still consume current when below operating voltage range for the shunt regulator.

13.3 Design Considerations

For more information on using the shunt regulator and managing current load, see Application Note AN1035, "*Designing with HV Microcontrollers"* (DS01035).

16.7 DC Characteristics: PIC12HV609/615-E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D020E	**Power-down Base Current (IPD)(2,3)** PIC12HV609/615	—	135	200	µA	2.0	WDT, BOR, Comparator, VREF and T1OSC disabled
		—	210	280	µA	3.0	
		—	260	350	µA	4.5	
D021E		—	135	200	µA	2.0	WDT Current(1)
		—	210	285	µA	3.0	
		—	265	360	µA	4.5	
D022E		—	215	285	µA	3.0	BOR Current(1)
		—	265	360	µA	4.5	
D023E		—	185	280	µA	2.0	Comparator Current(1), single comparator enabled
		—	265	360	µA	3.0	
		—	320	430	µA	4.5	
D024E		—	165	235	µA	2.0	CVREF Current(1) (high range)
		—	255	330	µA	3.0	
		—	330	430	µA	4.5	
D025E*		—	175	245	µA	2.0	CVREF Current(1) (low range)
		—	275	350	µA	3.0	
		—	355	450	µA	4.5	
D026E		—	140	205	µA	2.0	T1OSC Current(1), 32.768 kHz
		—	220	290	µA	3.0	
		—	270	360	µA	4.5	
D027E		—	210	280	µA	3.0	A/D Current(1), no conversion in progress
		—	260	350	µA	4.5	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 4.5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The peripheral current is the sum of the base IDD or IPD and the additional current consumed when this peripheral is enabled. The peripheral Δ current can be determined by subtracting the base IDD or IPD current from this limit. Max values should be used when calculating total current consumption.

2: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD.

3: Shunt regulator is always on and always draws operating current.

FIGURE 17-8: PIC12F609/615617 IDD EXTRC (4 MHz) vs. VDD

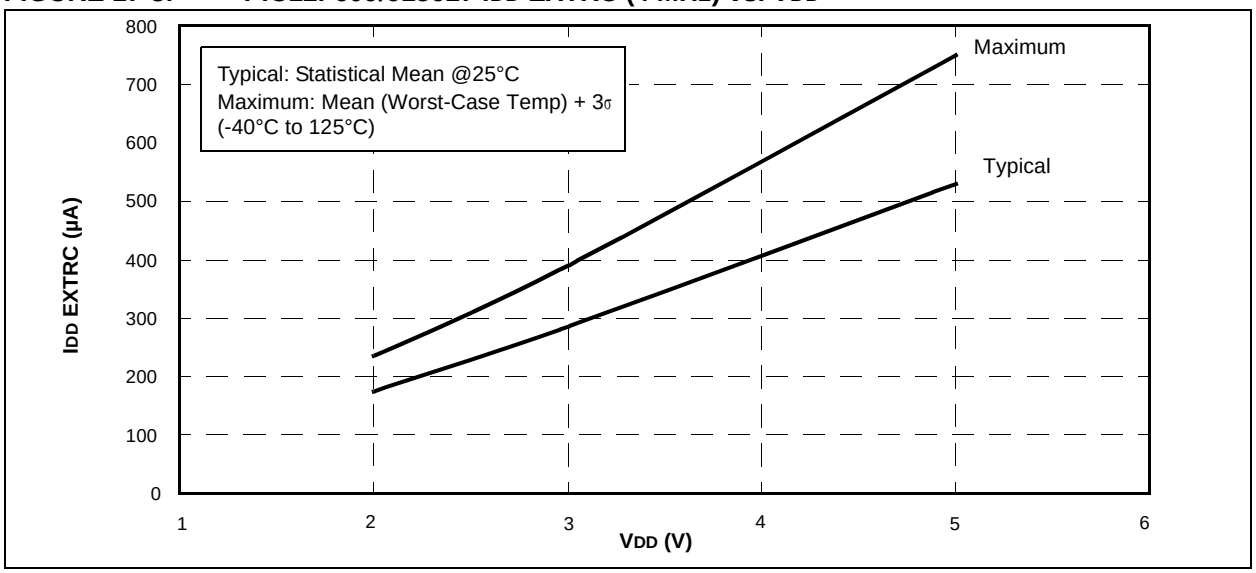


FIGURE 17-9: PIC12F609/615/617 IDD HS (20 MHz) vs. VDD

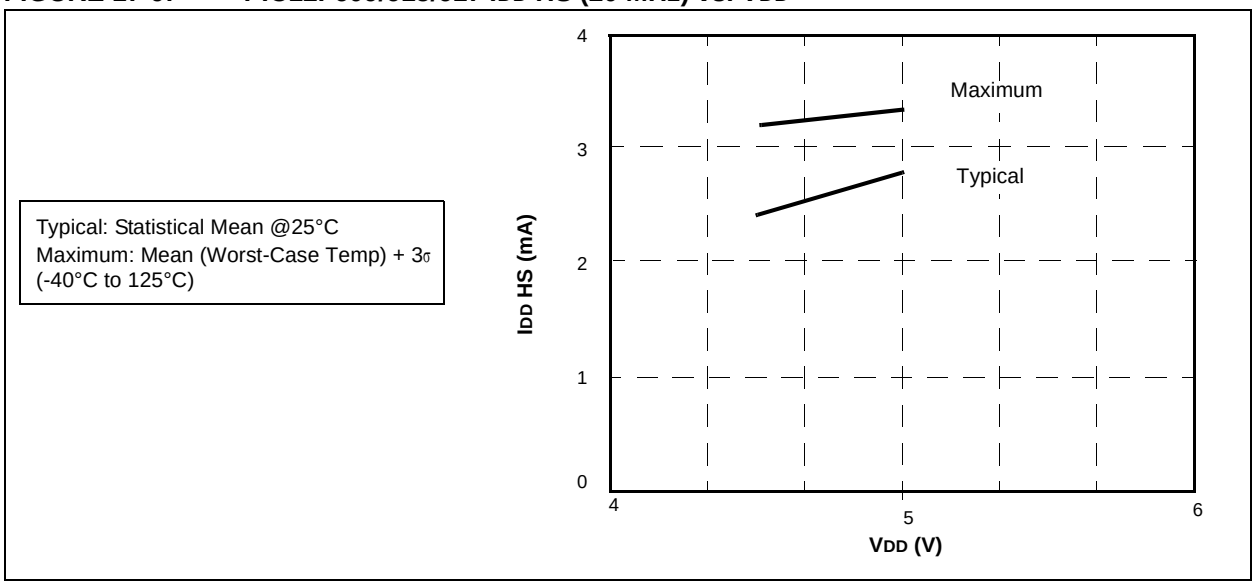


FIGURE 17-18: PIC12HV609/615 IDD LP (32 kHz) vs. VDD

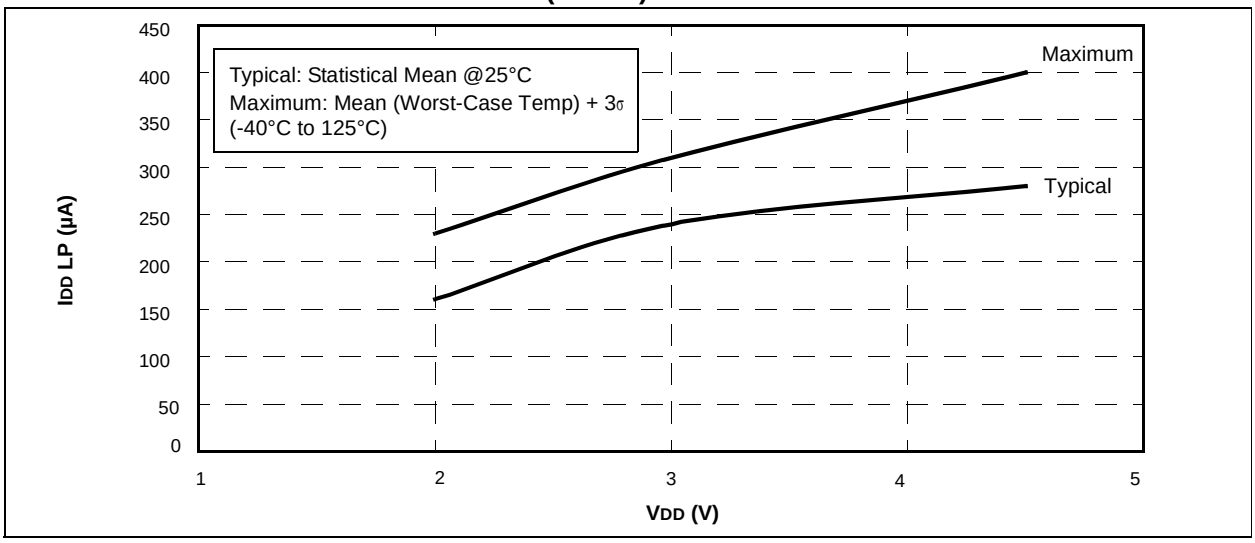


FIGURE 17-19: PIC12HV609/615 IDD EC (1 MHz) vs. VDD

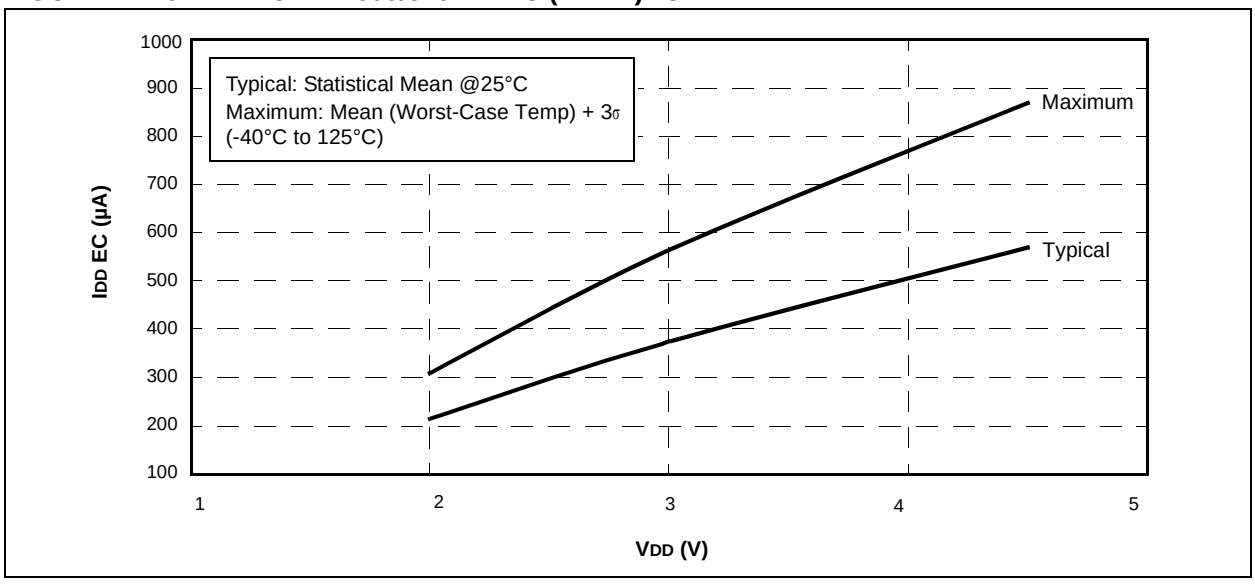


FIGURE 17-20: PIC12HV609/615 IDD EC (4 MHz) vs. VDD

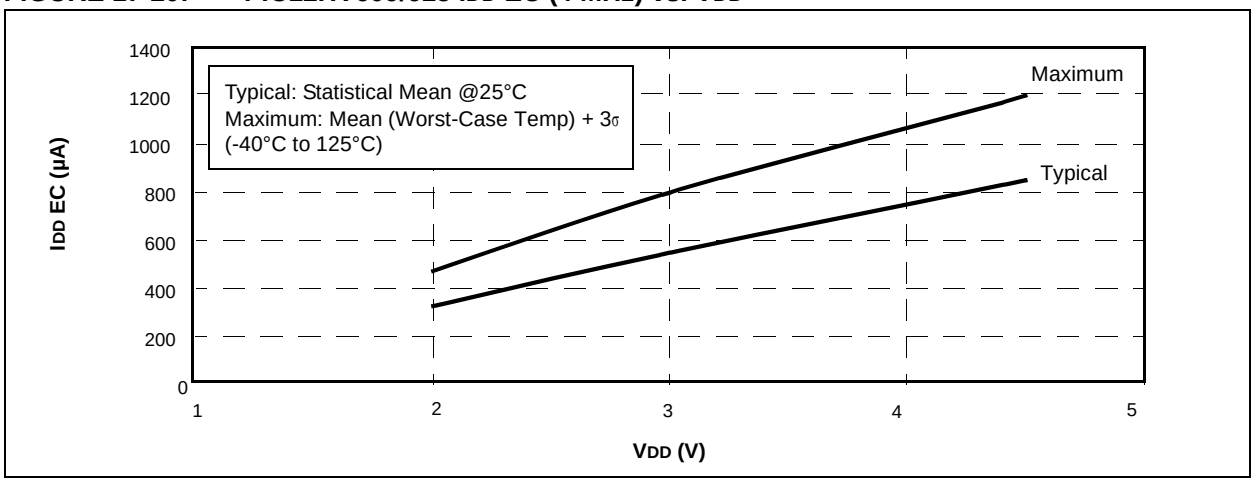


FIGURE 17-24: PIC12HV609/615 IDD INTOSC (8 MHz) vs. VDD

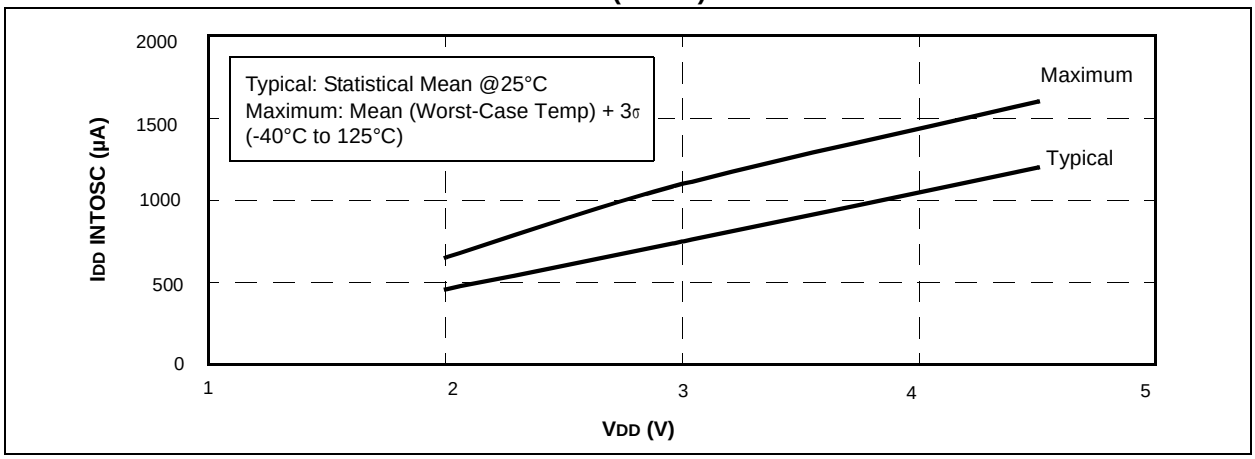


FIGURE 17-25: PIC12HV609/615 IDD EXTRC (4 MHz) vs. VDD

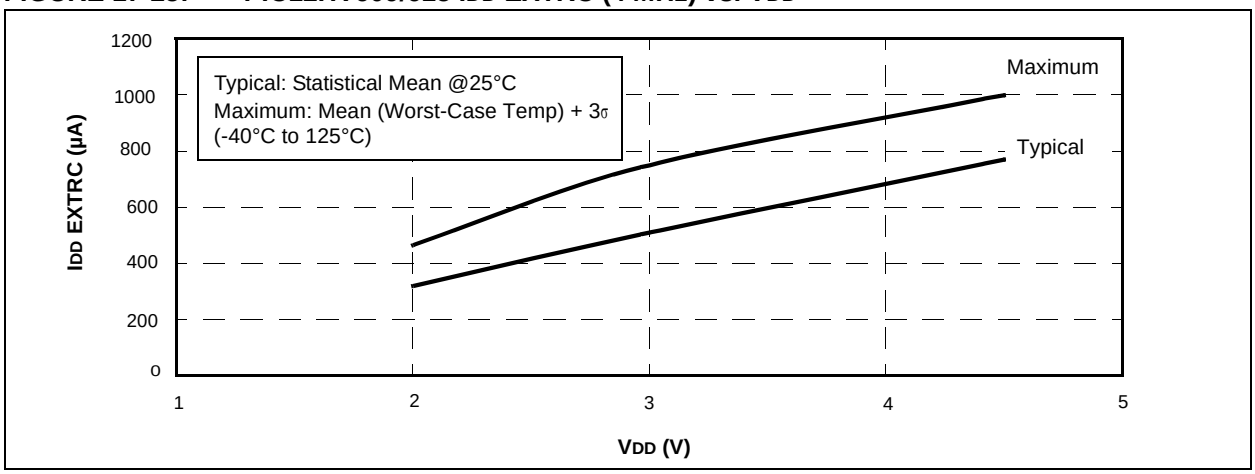


FIGURE 17-26: PIC12HV609/615 IPD BASE vs. VDD

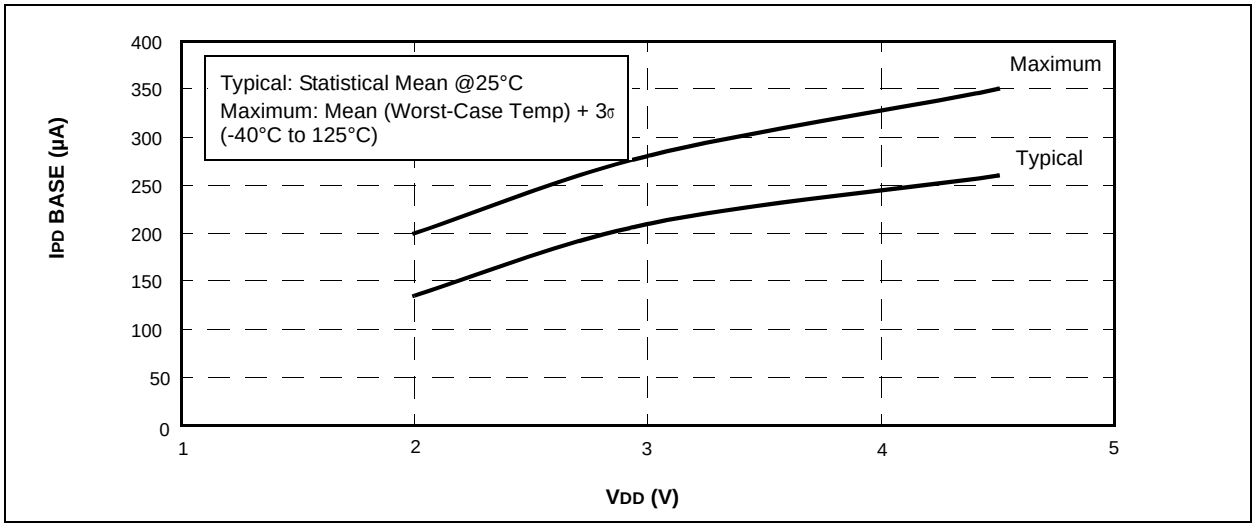


FIGURE 17-50: SHUNT REGULATOR VOLTAGE vs. TEMP (TYPICAL)

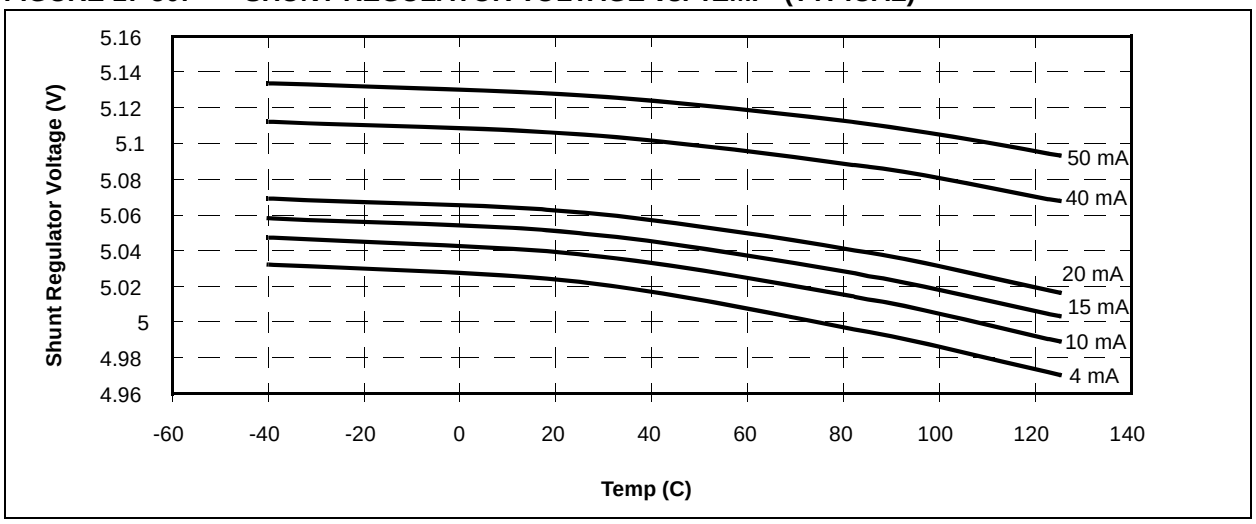
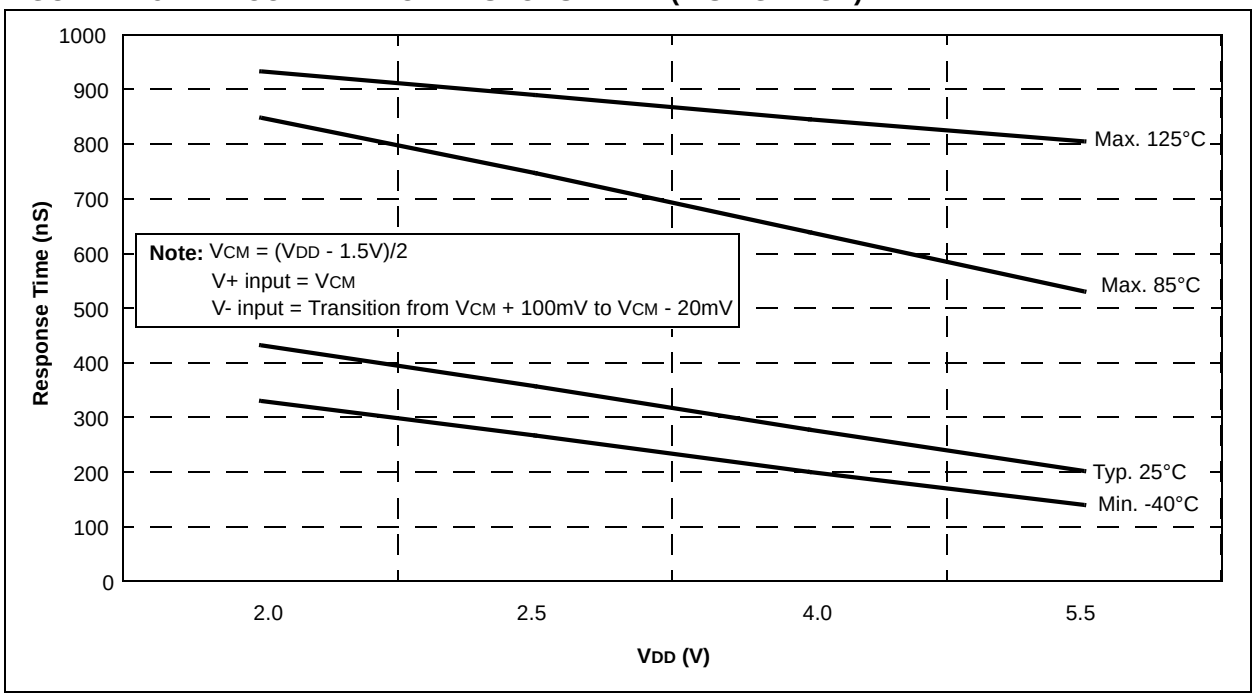
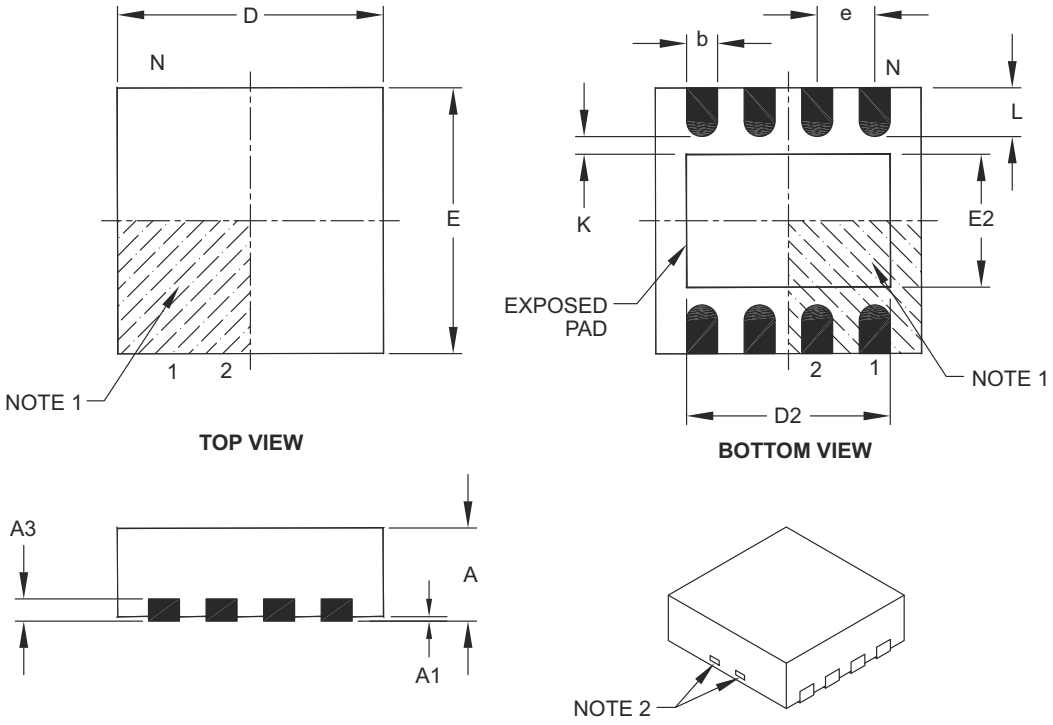


FIGURE 17-51: COMPARATOR RESPONSE TIME (RISING EDGE)



8-Lead Plastic Dual Flat, No Lead Package (MD) – 4x4x0.9 mm Body [DFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		8	
Pitch	e		0.80 BSC	
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3		0.20 REF	
Overall Length	D		4.00 BSC	
Exposed Pad Width	E2	0.00	2.20	2.80
Overall Width	E		4.00 BSC	
Exposed Pad Length	D2	0.00	3.00	3.60
Contact Width	b	0.25	0.30	0.35
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package may have one or more exposed tie bars at ends.
3. Package is saw singulated.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-131D

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